



AEMD-LY3N-12002 High Brightness White SMT Oval Lamps

Description

The new Broadcom[®] AEMD-LY3N series resembles conventional high-brightness though-hole LEDs in the form of surface-mount devices. It can be assembled using common SMT assembly processes and is compatible with an industrial reflow soldering process.

The LEDs are made with an advanced optical grade epoxy for superior performance in outdoor sign applications. For easy pick-and-place assembly, the LEDs are shipped in tape and reel. Every reel is shipped from a single intensity and color bin for better uniformity

Features

- High brightness InGaN
- Typical viewing angle: 110 × 50°
- Diffused lens
- JEDEC MSL3

Applications

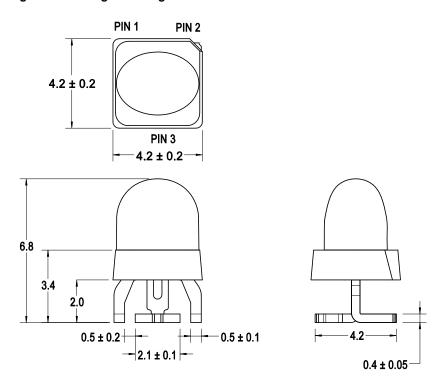
- Gas price signs
- Monocolor signs

CAUTION!

This LED is ESD sensitive. Observe appropriate precautions during handling and processing. Refer to application note AN-1142 for additional details.

Keep the LED in a moisture barrier bag with < 5% relative humidity (RH) when not in use because prolonged exposure to the environment might cause the leads to tarnish or rust, which might cause difficulties in soldering.

Figure 1: Package Drawing



Lead Configuration		
Pin 1	Anode	
Pin 2	Cathode	
Pin 3	Anode	

NOTE:

- 1. All dimensions in millimeters (mm).
- 2. Tolerance is \pm 0.50 mm unless otherwise specified.

Device Selection Guide ($T_J = 25$ °C, $I_F = 20$ mA)

	Chromaticity Coordinate	,		
Part Number	Тур.	Min.	Max.	Color Bin
AEMD-LY3N-12002	0.285, 0.262	2900	4200	1, 2, 3, 4, 5, 6

- a. The luminous intensity, I_V is measured at the mechanical axis of the package and it is tested with a single current pulse condition. The actual peak of the spatial radiation pattern may not be aligned with the axis.
- b. Tolerance is ± 15%

Absolute Maximum Ratings

Parameters	White	Units
DC Forward Current ^a	25	mA
Peak Forward Current ^b	100	mA
Power Dissipation	95	mW
Reverse Voltage	Not recommended for reverse bia	s operation
LED Junction Temperature	100	°C
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range	-40 to +100	°C

- a. Derate linearly as shown in Figure 11.
- b. Duty factor = 10%, frequency = 1 kHz.

Optical and Electrical Characteristics $(T_J = 25^{\circ}C)$

Parameters	Min.	Тур.	Max.	Units	Test Condition
Viewing Angle, 2θ _½ ^a	_	110 × 50	_	٥	I _F = 20 mA
Forward Voltage, V _F ^b	2.5	2.9	3.8	V	I _F = 20 mA
Reverse Voltage, V _R at I _R = 10 µA ^c	5	_	_	V	I _R = 10 μA
Chromaticity Coordinate	_	0.285, 0.262	_		I _F = 20 mA
Thermal Resistance, R _{θJ-P} ^d	_	400	_	°C/W	LED junction to pin

- a. $\theta_{\frac{1}{2}}$ is the off-axis angle where the luminous intensity is $\frac{1}{2}$ the peak intensity.
- b. Forward voltage tolerance is ± 0.1 V.
- c. Indicated product final test condition. Long term reverse bias is not recommended.
- d. Thermal resistance from LED junction to pin.

Part Numbering System

A E M D - x_1 Y 3 x_2 - x_3 x_4 x_5 x_6 x_7

Code	Description	Option	
x ₁	Package Type	L	SMT Oval
x ₂	Lens Appearance	N	Diffused
x ₃	Minimum Intensity Bin	1	2900 to 3500
x ₄	Maximum Intensity Bin	2	3500 to 4200
x ₅	Color Bin Option	0	Bin 1, 2, 3, 4, 5, 6
x ₆ , x ₇	Packaging Option	02	Test Current = 20 mA

Part Number Example

AEMD-LY3N-12002

 $x_1:L$ – SMT Oval

 $x_2: N$ – Diffused

 $x_3:1$ — Minimum intensity bin 1

 $x_4:2$ — Maximum intensity bin 2

 $x_5: 0$ — Color bin 1, 2, 3,4, 5, 6

 $x_6 x_7 : 02$ Tested at 20 mA

Bin Information

Intensity Bin Limits (CAT)

	Luminous Intensity, I _V (mcd)		
Bin ID	Min.	Max.	
1	2900	3500	
2	3500	4200	

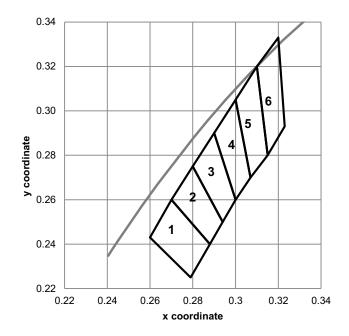
Tolerance = \pm 15%.

Color Bin Limits (BIN)

Tolerance = ± 1.0 nm.

	Chromaticity Coordinates		
Bin ID	x	у	
1	0.260	0.243	
	0.270	0.260	
	0.288	0.240	
	0.279	0.225	
2	0.270	0.260	
	0.280	0.275	
	0.294	0.250	
	0.288	0.240	
3	0.280	0.275	
	0.290	0.290	
	0.300	0.260	
	0.294	0.250	
4	0.290	0.290	
	0.300	0.305	
	0.307	0.270	
	0.300	0.260	
5	0.300	0.305	
	0.310	0.320	
	0.315	0.280	
	0.307	0.270	
6	0.310	0.320	
	0.320	0.333	
	0.323	0.293	
	0.315	0.280	

Figure 2: Chromaticity Diagram



Tolerance = ± 0.01 nm.

Figure 3: Spectral Power Distribution

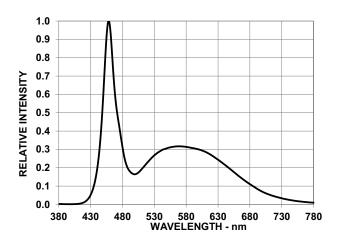


Figure 5: Relative Luminous Intensity vs. Mono Pulse Current

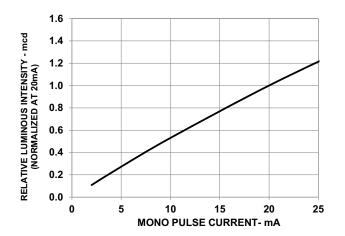


Figure 7: Relative Light Output vs. Junction Temperature

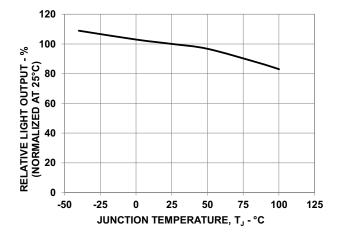


Figure 4: Forward Current vs. Forward Voltage

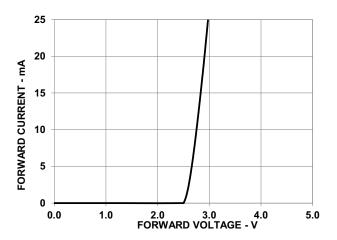


Figure 6: Chromaticity Coordinate Shift vs Mono Pulse Current

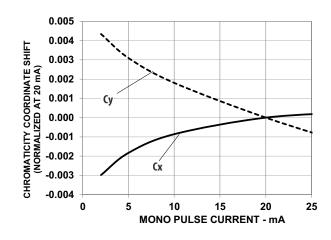


Figure 8: Forward Voltage Shift vs. Junction Temperature

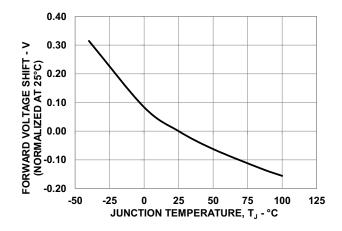


Figure 9: Chromaticity Coordinate Shift vs. Junction Temperature

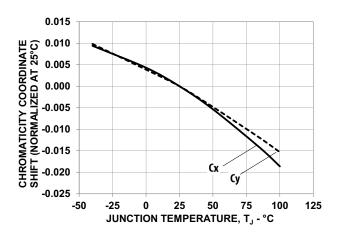


Figure 11: Maximum Forward Current vs. Ambient Temperature. Derate based on $T_{J\ MAX}$ = 100°C

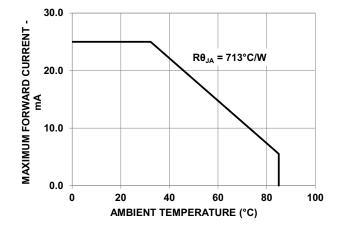


Figure 10: Radiation Pattern

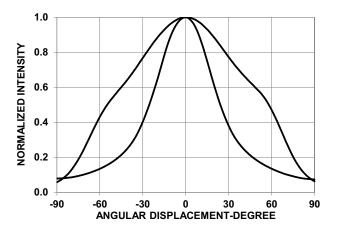
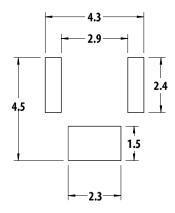


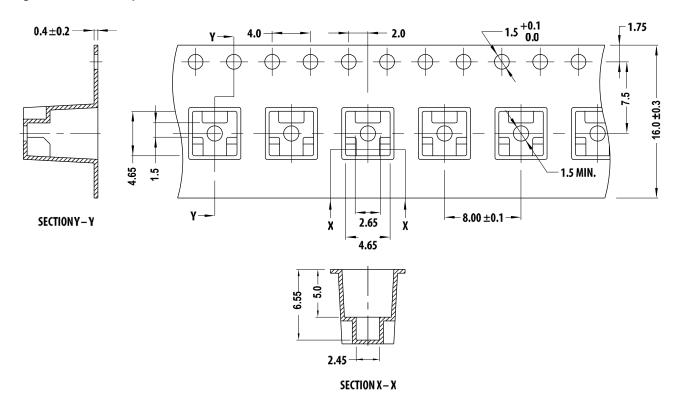
Figure 12: Recommended Soldering Pad Pattern



NOTE:

- 1. All dimensions are in millimeters (mm).
- 2. The recommended stencil thickness is 0.1524 mm (6 mil) minimum and above.

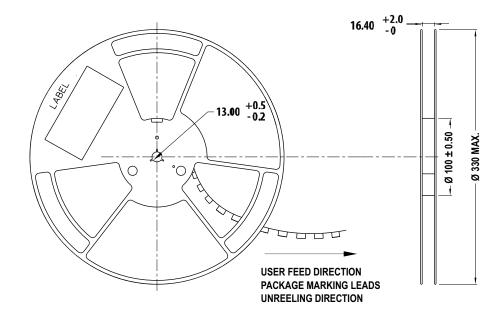
Figure 13: Carrier Tape Dimensions



NOTE:

- 1. All dimensions are in millimeters (mm).
- 2. Tolerance is \pm 0.10 mm unless otherwise specified.

Figure 14: Reel Dimensions

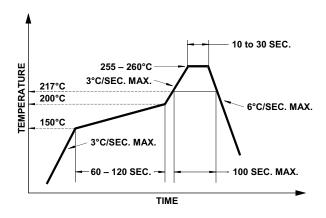


Precautionary Notes

Soldering

- Do not perform reflow soldering more than twice.
 Observe necessary precautions of handling moisture-sensitive devices as stated in the following section.
- Do not apply any pressure or force on the LED during reflow and after reflow while the LED is still hot.
- Use reflow soldering to solder the LED. Use hand soldering only for rework if unavoidable, but it must be strictly controlled to following conditions:
 - Soldering iron tip temperature = 315°C maximum
 - Soldering duration = 3 seconds maximum
 - Number of cycles = 1 only
 - Power of soldering iron = 50W maximum
- Do not touch the LED package body with the soldering iron except for the soldering terminals, as it may cause damage to the LED.
- Confirm before hand whether the functionality and performance of the LED is affected by soldering with hand soldering.

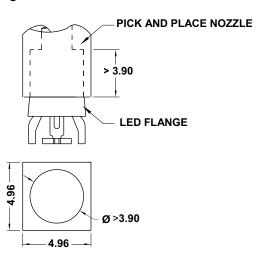
Figure 15: Recommended Lead-Free Reflow Soldering Profile



Handling Precautions

For automated pick and place, Broadcom has tested following nozzle size (Figure 16) to work with this LED. However, due to the possibility of variations in other parameters, such as pick and place, machine maker/model, and other settings of the machine, verify that the selected nozzle performs as per requirements.

Figure 16: Recommended Nozzle Dimension



NOTE:

- 1. The nozzle tip must touch the LED flange during pick and place.
- 2. The outer dimensions of the nozzle tip must be able to fit into the carrier tape pocket until it touches the LED flange.
- 3. All dimensions are in millimeters (mm).

Handling of Moisture-Sensitive Devices

This product has a Moisture Sensitive Level 3 rating per JEDEC J-STD-020. Refer to Broadcom Application Note AN5305, *Handling of Moisture Sensitive Surface Mount Devices* for additional details and a review of proper handling procedures.

Before use:

- An unopened moisture barrier bag (MBB) can be stored at <40°C/90% RH for 12 months. If the actual shelf life has exceeded 12 months and the humidity indicator card (HIC) indicates that baking is not required, it is safe to reflow the LEDs per the original MSL rating.
- Do not open the MBB prior to assembly (for example, for IQC). If unavoidable, the MBB must be properly resealed with fresh desiccant and HIC. The exposed duration must be taken in as floor life.

Control after opening the MBB:

- Read the HIC immediately upon opening of the MBB.
- Keep the LEDs at <30°/60%RH at all times, and complete all high temperature-related processes, including soldering, curing or rework within 168 hours.

Control for unfinished reel:

Store unused LEDs in a sealed MBB with desiccant or a desiccator at <5% RH.

Control of assembled boards:

If the PCB soldered with the LEDs is to be subjected to other high-temperature processes, store the PCB in a sealed MBB with desiccant or a desiccator at <5% RH to ensure that all LEDs have not exceeded their floor life of 168 hours.

Baking is required if the following conditions exist:

- The HIC indicator indicates a change in color for 10% and 5%, as stated on the HIC.
- The LEDs are exposed to conditions of >30°C/60% RH at any time.
- The LED's floor life exceeded 168 hours.

The recommended baking condition is: 60°± 5°C for 20 hours.

Baking can only be done once.

Storage:

The soldering terminals of these Broadcom LEDs are silver plated. If the LEDs are exposed in an ambient environment for too long, the silver plating might be oxidized, thus affecting its solderability performance. As such, keep unused LEDs in a sealed MBB with desiccant or in a desiccator at <5% RH.

Application Precautions

- The drive current of the LED must not exceed the maximum allowable limit across temperature as stated in the data sheet. Constant current driving is recommended to ensure consistent performance.
- The circuit design must cater to the entire range forward voltage (V_F) of the LEDs to ensure that the intended drive current can always be achieved.
- The LED exhibits slightly different characteristics at different drive currents, which may result in a larger variation of performance (such as intensity, wavelength, and forward voltage). Set the application current as close as possible to the test current to minimize these variations.
- The LED is not intended for reverse bias. Use other appropriate components for such purposes. When driving the LED in matrix form, ensure that the reverse bias voltage does not exceed the allowable limit of the LED.
- White LEDs must not be exposed to acidic environments and must not be used in the vicinity of any compound that may have acidic outgas, such as, but not limited to, acrylate adhesive. These environments have an adverse effect on LED performance.
- Avoid rapid changes in ambient temperatures, especially in high-humidity environments, because they cause condensation on the LED.
- If the LED is intended to be used in harsh or outdoor environments, protect the LED against damages caused by rain water, water, dust, oil, corrosive gases, external mechanical stresses, and so on.
- The number of reflow cycles and reflow temperature conditions used may affect the optical characteristics of the LED. Use the LED with the same number of reflow cycles and the same reflow temperature conditions within the same finished good.

Thermal Management

The optical, electrical, and reliability characteristics of the LED are affected by temperature. Keep the junction temperature (T_J) of the LED below the allowable limit at all times. T_J can be calculated as follows:

$$T_J = T_A + R_{\theta J-A} \times I_F \times V_{Fmax}$$

where:

T_A =Ambient temperature (°C)

 $R_{\theta J\text{-}A}$ = Thermal resistance from the LED junction to ambient (°C/W)

I_F = Forward current (A)

V_{Fmax} = Maximum forward voltage (V)

The complication of using this formula lies in T_A and $R_{\theta J-A}$. Actual T_A is sometimes subjective and hard to determine. $R_{\theta J-A}$ varies from system to system depending on the design and is usually not known.

Another way of calculating T_J is by using the solder point temperature, T_S as follows:

$$T_J = T_S + R_{\theta J-S} \times I_F \times V_{Fmax}$$

where:

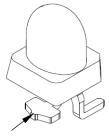
 T_S = LED solder point temperature as shown in the following figure (°C)

 $R_{\theta J-S}$ = Thermal resistance from junction to solder point (°C/W)

IF = Forward current (A)

V_{Fmax} = Maximum forward voltage (V)

Figure 17: Solder Point Temperature on the PCB



Ts Point

 T_S can be easily measured by mounting a thermocouple on the soldering joint as shown in preceding figure, while $R_{\theta J\text{-}S}$ is provided in the data sheet. Verify the T_S of the LED in the final product to ensure that the LEDs are operating within all maximum ratings stated in the data sheet.

Eye Safety Precautions

LEDs may pose optical hazards when in operation. Do not look directly at operating LEDs because it might be harmful to the eyes. For safety reasons, use appropriate shielding or personal protective equipment.

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